

## **Technical Data Sheet**

# 0603 Package Chip LED (0.8mm Height)

### 19-21/BHC-AN1P2F/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

### **Descriptions**

- The 19-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

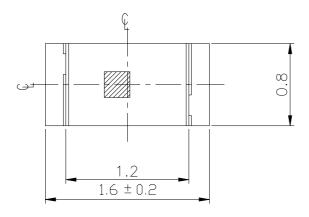
D (N		T 0.1	
Part No.	Material	Emitted Color	Lens Color
19-21/BHC-AN1P2F/3T	InGaN	Blue	Water Clear

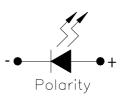


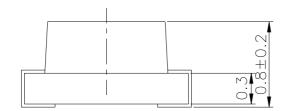
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 10

Device No.:SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan

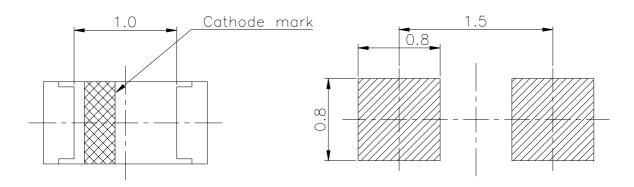
## **Package Outline Dimensions**







For reflow soldering (Propose)



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. Device No.: SZDSE-191-B22 http://www.everlight.com

Rev.1 Page: 2 of 10 Prepared by:Xiaoyan

Prepared date: 20-Dec-2006



### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	$V_R$	5	V
Forward Current	$I_{\mathrm{F}}$	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	100	mA
Power Dissipation	Pd	110	mW
Electrostatic Discharge(HBM)	ESD	150	V
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\! \mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\! \mathbb{C}$
Soldering Temperature	Tsol	Reflow Soldering: 260°C for 10sec. Hand Soldering: 350°C for 3 sec.	

# **Electro-Optical Characteristics** (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	$I_V$	28.5		72.0	mcd		
Viewing Angle	2 \theta 1/2		100		deg		
Peak Wavelength	λp		468		nm		
Dominant Wavelength	λd	464.5		476.5	nm	$I_F=20\text{mA}$	
Spectrum Radiation Bandwidth	Δλ		35		nm		
Forward Voltage	$V_{\mathrm{F}}$	2.70		3.50	V		
Reverse Current	$I_R$			50	$\mu$ A	V <sub>R</sub> =5V	

#### **Notes:**

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10

Device No.: SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan



## Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
A	A9	464.5	467.5			
	A10	467.5	470.5	nm	I <sub>F</sub> =20mA	
	A11	470.5	473.5			
	A12	473.5	476.5			

## **Bin Range Of Luminous Intensity**

				1	
Bin	Min	Max	Unit	Condition	
N1	28.5	36.0			
N2	36.0	45.0	1	I <sub>F</sub> =20mA	
P1	45.0	57.0	mcd		
P2	57.0	72.0			

## **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition	
F	10	2.70	2.90			
	11	2.90	3.10	<b>T</b> 7	I <sub>F</sub> =20mA	
	12	3.10	3.30	V		
	13	3.30	3.50			

#### **Notes:**

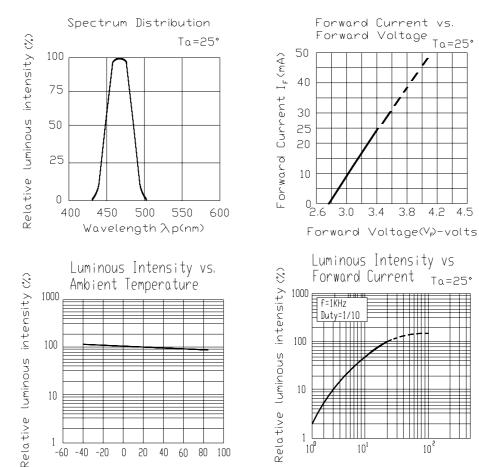
1.Tolerance of Luminous Intensity ±10%

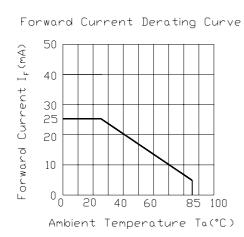
2.Tolerance of Dominant Wavelength ±1nm

3. Tolerance of Forward Voltage ±0.1V

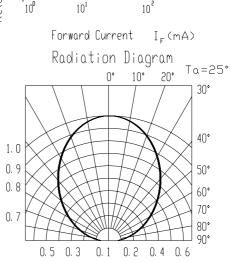
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 10 Device No.: SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan

## **Typical Electro-Optical Characteristics Curves**





Ambient Temperature Ta(°C)



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 10 Device No.: SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan

### Label explanation

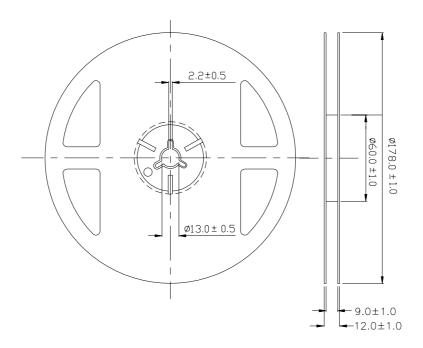
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

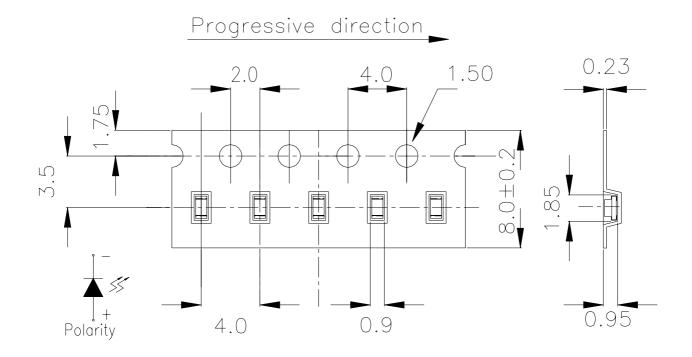
Everlight Electronics Co., Ltd. Device No. : SZDSE-191-B22 http://www.everlight.com

Rev.1 Page: 6 of 10

Prepared date: 20-Dec-2006

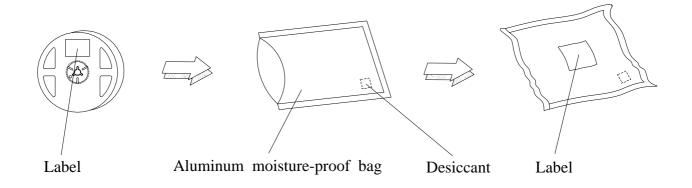
Prepared by:Xiaoyan

## Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

## **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd. Device No.: SZDSE-191-B22 http://www.everlight.com

Prepared date: 20-Dec-2006

Rev.1 Page: 7 of 10

Prepared by:Xiaoyan



## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/RH85%	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 10 Device No.: SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan



#### **Precautions For Use**

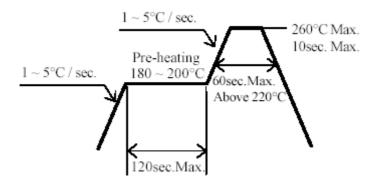
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
  - 2.3 The LEDs should be used within a year.
  - 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 60%RH or less.
  - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
  - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

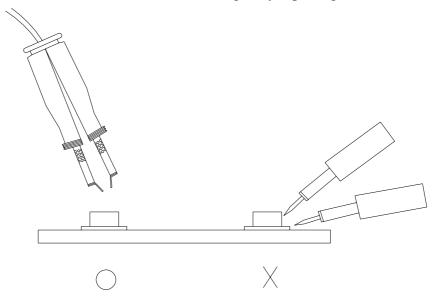
Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 10 Device No.: SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan



#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 10 Device No.: SZDSE-191-B22 Prepared date: 20-Dec-2006 Prepared by:Xiaoyan